

REGULATORY COMPLIANCE STATEMENT

January 2016

Dear Valued Customer:

Epoxy Technology, Inc. hereby certifies that EPO-TEK® brand products are in full compliance with the following Directives and Regulations:

- EU Directive 2011/65/EU of 8 June 2011 referencing EU Directive 2002/95/EC (RoHS) of 27 January 2003 and as amended by EU Directive 2015/863/EU of 31 March 2015 on the restriction of the use of certain hazardous substances in electrical and electronic equipment Restriction of Hazardous Substances (RoHS) List of Controlled Substances lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls (PBB), polybrominated diphenyl ethers (PBDE), Bis(2-ethylhexyl) phthalate (DEHP), Benzyl butyl phthalate (BBP), Dibutyl phthalate (DBP) and Diisobutyl phthalate (DIBP) with no exemptions.
- Commission Decision of 18 August 2005 Amending Directive 2002/95/EC of the European Parliament and of the Council for the purpose of establishing the maximum concentration values for certain hazardous substances in electrical and electronic equipment (2005/618/EC).
- **EU Directive 2003/11/EC of 6 February 2003** amending for the 24th time Council Directive 76/769/EEC relating to restrictions on the marketing and use of certain dangerous substances and preparations pentabromodiphenyl ether (pentaBDE) and octabromodiphenyl ether (octaBDE).
- **EU Directive 2006/122/EC of 12 December 2006** amending for the 30th time Council Directive 76/769/EEC on the approximation of the laws, regulations and administrative provisions of the Member States relating to restrictions on the marketing and use of certain dangerous substances and preparations PFOS (perfluorooctane sulfonates).
- EC Regulation No 1907/2006 of the European Parliament and of the Council of 18 December 2006*known as REACH (Registration, Evaluation, Authorization, and Restriction of Chemicals) including the SVHC List, current edition.

 *except the 302 and OM125 product families.

Based upon our knowledge of the manufacturing processes and the raw materials utilized, the restricted substances proscribed above are not expected to be present in our final products in levels exceeding the limitations set forth in the above regulations. Testing is available from Epoxy Technology, Inc. for a fee.

In addition:

- **ACPEIP** (Administration on the Control of Pollution Caused by Electronic Information Products of February 28, 2006) at this time, none of our products fall directly into the scope of this "China RoHS" legislation. When incorporating any of our epoxies into a product that may be in scope, we can confirm that EPO-TEK® brand products do not contain lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls (PBB) or polybrominated diphenyl ether (PBDE).
- Section 1502 of the Dodd-Frank Wall Street Reform and Consumer Protection Act ("Conflict Minerals Trade Act") Pursuant to information supplied by our Raw Material Suppliers, no materials are derived from or sourced from mines in the Democratic Republic of Congo (DRC) or adjoining countries.
- **DFARS 252.225-7009** Restriction on Acquisition of Certain Articles Containing Specialty Metals EPO-TEK® brand products are not specialty metals and do not contain specialty metals as defined by DFARS.
- EPO-TEK® brand products comply with Sony's Management Regulations for Environment related Substances to be Controlled (*SS-00259*, current edition).
- Epoxy Technology does not test its products for **UL certification**. **Underwriters Laboratories (UL)** tests and certifies product safety for a number of industries including food/drinking water, consumer appliances and electronics, AC/HV systems, etc. UL certification is only required for a completed device. While components such as adhesives can be tested, testing is by no means required or a condition of product safety.

Epoxy Technology identifies all hazardous materials contained in our products on each individual product SDS, all of which are available on our website – www.epotek.com.

Sincerely.

We appreciate your business.

Andrew R. Horne - President / COO